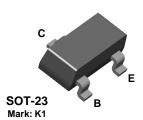


# **BCW71**



# **NPN General Purpose Amplifier**

This device is designed for general purpose amplifier applications at collector currents to 300 mA. Sourced from Process 10.

#### **Absolute Maximum Ratings\*** TA = 25°C unless otherwise noted

| Symbol                            | Parameter                                        | Value       | Units |
|-----------------------------------|--------------------------------------------------|-------------|-------|
| $V_{CEO}$                         | Collector-Emitter Voltage                        | 45          | V     |
| V <sub>CES</sub>                  | Collector-Base Voltage                           | 50          | V     |
| V <sub>EBO</sub>                  | Emitter-Base Voltage                             | 5.0         | V     |
| Ic                                | Collector Current - Continuous                   | 500         | mA    |
| T <sub>J</sub> , T <sub>stg</sub> | Operating and Storage Junction Temperature Range | -55 to +150 | °C    |

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

## Thermal Characteristics TA = 25°C unless otherwise noted

| Symbol          | Characteristic                             | Max        | Units       |  |
|-----------------|--------------------------------------------|------------|-------------|--|
|                 |                                            | *BCW71     |             |  |
| $P_D$           | Total Device Dissipation Derate above 25°C | 350<br>2.8 | mW<br>mW/°C |  |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient    | 357        | °C/W        |  |

<sup>\*</sup>Device mounted on FR-4 PCB 40 mm X 40 mm X 1.5 mm.

# **NPN General Purpose Amplifier**

(continued)

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|-------|------|----|-----|-----|-----|-----|--|
| ecu   | ICAL | GH | ลเล | сте | 115 | EIC |  |

TA = 25°C unless otherwise noted

| Symbol               | Parameter                           | Test Conditions                                                                                       | Min | Тур | Max       | Units |
|----------------------|-------------------------------------|-------------------------------------------------------------------------------------------------------|-----|-----|-----------|-------|
| OEE CHAE             | RACTERISTICS                        |                                                                                                       |     |     |           |       |
|                      | •                                   | T                                                                                                     |     | 1   | 1         |       |
| $V_{(BR)CEO}$        | Collector-Emitter Breakdown Voltage | $I_C = 1.0 \text{ mA}, I_B = 0$                                                                       | 45  |     |           | V     |
| V <sub>(BR)CBO</sub> | Collector-Base Breakdown Voltage    | $I_C = 10 \mu A, I_E = 0$                                                                             | 50  |     |           | V     |
| V <sub>(BR)EBO</sub> | Emitter-Base Breakdown Voltage      | $I_E = 10 \ \mu A, \ I_C = 0$                                                                         | 5.0 |     |           | V     |
| I <sub>CBO</sub>     | Collector-Cutoff Current            | $V_{CB} = 20 \text{ V}, I_{E} = 0$<br>$V_{CB} = 20 \text{ V}, I_{E} = 0, T_{A} = 100^{\circ}\text{C}$ |     |     | 100<br>10 | μА    |

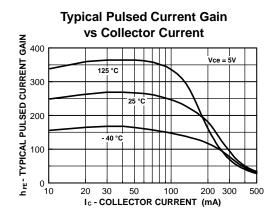
### **ON CHARACTERISTICS**

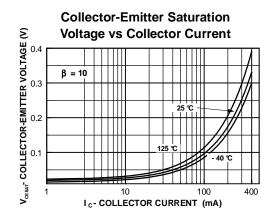
| h <sub>FE</sub>      | DC Current Gain                      | $I_C = 2.0 \text{ mA}, V_{CE} = 5.0 \text{ V}$ | 110 |      | 220  |   |
|----------------------|--------------------------------------|------------------------------------------------|-----|------|------|---|
| V <sub>CE(sat)</sub> | Collector-Emitter Saturation Voltage | $I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$    |     |      | 0.25 | V |
| V <sub>BE(sat)</sub> | Base-Emitter Saturation Voltage      | $I_C = 50 \text{ mA}, I_B = 2.5 \text{ mA}$    |     | 0.85 |      | V |
| V <sub>BE(on)</sub>  | Base-Emitter On Voltage              | $I_C = 2.0 \text{ mA}, V_{CE} = 5.0 \text{ V}$ | 0.6 |      | 0.75 | V |

### SMALL SIGNAL CHARACTERISTICS

| f <sub>T</sub>   | Current Gain - Bandwidth Product | $I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V},$<br>f = 35  MHz                                                            | 330 |     | MHz |
|------------------|----------------------------------|--------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|
| C <sub>obo</sub> | Output Capacitance               | $V_{CE} = 10 \text{ V}, I_{E} = 0, f = 1.0 \text{ MHz}$                                                                  |     | 4.0 | pF  |
| C <sub>ibo</sub> | Input Capacitance                | $V_{EB} = 0.5 \text{ V}, I_{C} = 0, f = 1.0 \text{ MHz}$                                                                 | 9.0 |     | pF  |
| NF               | Noise Figure                     | $I_{C} = 0.2 \text{ mA}, V_{CE} = 5.0 \text{ V},$<br>$R_{S} = 2.0 \text{ k}\Omega, f = 1.0 \text{ kHz},$<br>BW = 200  Hz |     | 10  | dB  |

# **Typical Characteristics**

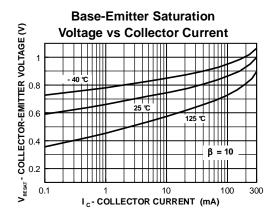


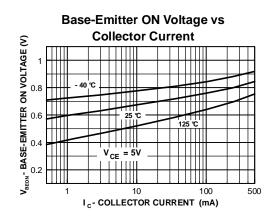


# **NPN General Purpose Amplifier**

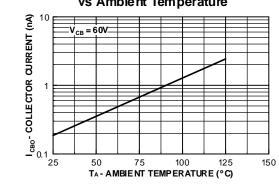
(continued)

# Typical Characteristics (continued)

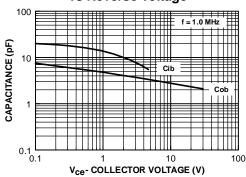




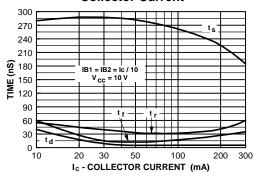
# Collector-Cutoff Current vs Ambient Temperature



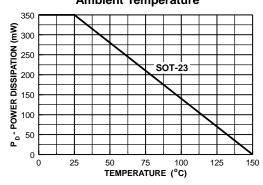
# Input and Output Capacitance vs Reverse Voltage



Switching Times vs Collector Current



Power Dissipation vs Ambient Temperature



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#### PRODUCT STATUS DEFINITIONS

#### **Definition of Terms**

| Datasheet Identification | Product Status            | Definition                                                                                                                                                                                                            |  |  |  |
|--------------------------|---------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|
| Advance Information      | Formative or<br>In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.                                                                                    |  |  |  |
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